

PATENT ASSIGNMENT

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 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kwan-Yong Lim</td> <td>04/23/2013</td> </tr> <tr> <td>Hong-Seon Yang</td> <td>04/23/2013</td> </tr> <tr> <td>Heung-Jae Cho</td> <td>04/23/2013</td> </tr> <tr> <td>Tae-Kyung Kim</td> <td>04/23/2013</td> </tr> <tr> <td>Yong-Soo Kim</td> <td>04/23/2013</td> </tr> <tr> <td>Min-Gyu Sung</td> <td>04/23/2013</td> </tr> </tbody> </table>		Name	Execution Date	Kwan-Yong Lim	04/23/2013	Hong-Seon Yang	04/23/2013	Heung-Jae Cho	04/23/2013	Tae-Kyung Kim	04/23/2013	Yong-Soo Kim	04/23/2013	Min-Gyu Sung	04/23/2013
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Yong-Soo Kim	04/23/2013														
Min-Gyu Sung	04/23/2013														
RECEIVING PARTY DATA															
Name:	SK hynix Inc.														
Street Address:	2091, Gyeongchung-daero, Bubal-eub														
City:	Icheon-si, Gyeonggi-do														
State/Country:	KOREA, REPUBLIC OF														
PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13891648</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13891648										
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Application Number:	13891648														
CORRESPONDENCE DATA															
Fax Number: <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 206-224-2863 Email: kpedersen@kilpatricktownsend.com Correspondent Name: Kilpatrick Townsend & Stockton LLP/SK hy Address Line 1: Two Embarcadero Center Address Line 2: Eighth Floor Address Line 4: San Francisco, CALIFORNIA 94111-3834															
ATTORNEY DOCKET NUMBER:	85159-871472 (113911US)														
NAME OF SUBMITTER:	Kelly Pedersen														

OP \$40.00 13891648

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PATENT
REEL: 030394 FRAME: 0989

Signature:	/Kelly Pedersen/
Date:	05/10/2013
Total Attachments: 7 source=ASN_85159-871472-113911US#page1.tif source=ASN_85159-871472-113911US#page2.tif source=ASN_85159-871472-113911US#page3.tif source=ASN_85159-871472-113911US#page4.tif source=ASN_85159-871472-113911US#page5.tif source=ASN_85159-871472-113911US#page6.tif source=ASN_85159-871472-113911US#page7.tif	

ASSIGNMENT
(Patent Application)

We [I], the undersigned, have invented certain inventions and improvements disclosed in a utility (provisional or non-provisional) or design patent application entitled

“SEMICONDUCTOR DEVICE WITH GATE STACK STRUCTURE,”

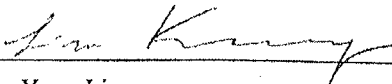
the specification of which is provided with this Assignment and identified by the Attorney Docket No. above. (Serial No. _____ filed on _____)

For one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which we [I] acknowledge, we [I]:

1. Agree to assign, transfer, convey, and sell, hereby assign, transfer, convey, and sell and have assigned, transferred, conveyed, and sold to SK hynix Inc., a corporation of Korea having a principal place of business at 2091, Gyeongchung-daero, Bubal-eub, Icheon-si, Gyeonggi-do, Republic of Korea (“Assignee”), the entire right, title, and interest in and to:
 - (a) all intellectual property (including, without limitation, any innovation, information, invention, discovery, product, process, work or design) disclosed, embodied, shown, or claimed in the above-referenced patent application, implicitly or explicitly;
 - (b) the above-referenced patent application, the right to claim priority to the above-referenced patent application, all applications based in whole or in part upon the above-referenced patent application, including, without limitation, all applications that are a provisional, non-provisional, design, divisional, continuation, continuation-in-part, registration, utility model, industrial design, reissue, renewal, substitute, extension, reexamination, post-grant review, inter partes review, supplemental examination or non-U.S. patent application or application for other rights based in whole or in part on the above-referenced patent application;
 - (c) all patents (including, without limitation, all U.S. and non-U.S. patents, registrations, utility models, industrial designs, design patents, counterparts, continuations, continuations-in-part, divisionals, reissues, renewals, substitutes, extensions, reexaminations, post-grant reviews, inter partes reviews and supplemental examinations) that are granted or issued upon, or that claim priority to, any and all applications described in (b) of this paragraph or that disclose or claim intellectual property described in (a) of this paragraph, in whole or in part; and

- (d) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.
2. Authorize and request the U.S. Patent and Trademark Office or any other U.S. or non-U.S. agency to issue to the Assignee any and all patent(s), or other rights or documents, resulting from the intellectual property, patent application(s) and patents described in paragraph 1 of this Assignment.
 3. Agree to sign all papers and documents, including without limitation, applications, declarations, oaths and petitions, and, at the Assignee's expense, perform any other acts that are necessary in connection with prosecution of patent application(s) or intellectual property described in paragraph 1 of this Assignment and the enforcement of patent(s) or other rights resulting from such patent application(s) or intellectual property.
 4. Agree that the terms, covenants, and conditions of this Assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon us [me], as well as our [my] heirs, legal representatives, and assigns.
 5. Promise and affirm that we [I] have not entered, and will not enter, into any assignment, contract, or understanding that conflicts with this Assignment.
 6. Authorize Kilpatrick Townsend & Stockton to insert above the application number and filing date of the above-described patent application when known.

Signed on the dates indicated beside our [my] signatures [signature].

Signature:  Date: April 23, 2013
Kwan-Yong Lim

Signature: _____ Date: _____
Hong-Seon Yang

- (d) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.
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Signed on the dates indicated beside our [my] signatures [signature].

Signature: _____ Date: _____
Kwan-Yong Lim

Signature: Hong Scon Yang Date: April 23, 2013
Hong-Scon Yang

ASSIGNMENT
SEMICONDUCTOR DEVICE WITH GATE STACK STRUCTURE
Attorney Docket No. 85159-871472 (113911US)
Page 3 of 3

Signature: _____
Heung-Jae Cho

Date: April 23, 2013

Signature: _____
Tae-Kyung Kim

Date: _____

Signature: _____
Yong-Soo Kim

Date: _____

Signature: _____
Min-Gyu Sung

Date: _____

Signature: _____
Heung-Jae Cho

Date: _____

Signature: kim taek byung
Tae-Kyung Kim

Date: April 23, 2013

Signature: _____
Yong-Soo Kim

Date: _____

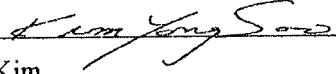
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Yong-Soo Kim

Date: _____

Signature: Min Gyu Sung
Min-Gyu Sung

Date: April 23, 2013